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PATENT  
3885-0102P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: Hisashi YAMADA et al. Conf.: 2551  
Appl. No.: 10/046,739 Group: 2814  
Filed: January 17, 2002 Examiner: HOA B. TRINH  
For: THIN-FILM CRYSTAL WAFER HAVING PN  
JUNCTION AND METHOD FOR FABRICATING THE  
WAFER

STATUS INQUIRY

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

JAN 25 2005

Sir:

Please advise the undersigned as to the status of the above-identified application as follows:

**Status of Office Action**

A duplicate copy of the present Status Inquiry is attached hereto. It is respectfully requested that the duplicate copy be marked appropriately to indicate the status of the above-identified application and returned to the undersigned as soon as possible.

Please call the undersigned if there are any questions with regard to the present request.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP

By   
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- ☐ Awaiting Action from Patent Office Examiner - Expected Date for Action is: \_\_\_\_\_.
- ☐ Awaiting Decision by Board of Appeals.
- ☐ Application allowed on \_\_\_\_\_.
- ☐ Abandoned per \_\_\_\_\_.
- ☐ Other \_\_\_\_\_.